

SN54ABT620, SN74ABT620 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS113D – FEBRUARY 1991 – REVISED APRIL 1998

- State-of-the-Art **EPIC-IITM** BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- High-Drive Outputs (–32-mA I_{OH} , 64-mA I_{OL})
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK), and Plastic (N) and Ceramic (J) DIPs

description

These octal bus transceivers provide for asynchronous communication between data buses. The control-function implementation allows for maximum flexibility in timing. The 'ABT620 devices provide inverted data at the outputs.

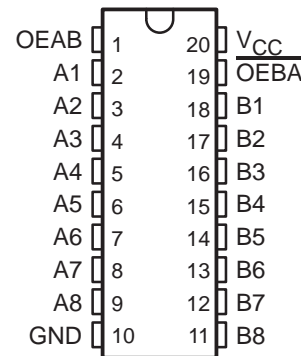
These devices allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic levels at the output-enable (OEAB and $\overline{\text{OEBA}}$) inputs.

The output-enable inputs can be used to disable the device so that the buses are effectively isolated. The dual-enable configuration gives the transceivers the capability of storing data by simultaneously enabling OEAB and $\overline{\text{OEBA}}$. When both OEAB and $\overline{\text{OEBA}}$ are enabled and all other data sources to the two sets of bus lines are at high impedance, both sets of bus lines (16 total) remain at their last states. In this way, each output reinforces its input in this configuration.

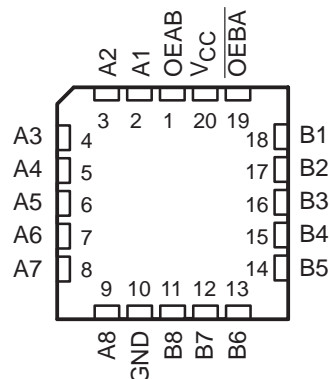
To ensure the high-impedance state during power up or power down, $\overline{\text{OEBA}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver. OEAB should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The SN54ABT620 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ABT620 is characterized for operation from -40°C to 85°C .

SN54ABT620 . . . J PACKAGE
SN74ABT620 . . . DB, DW, N, OR PW PACKAGE
(TOP VIEW)



SN54ABT620 . . . FK PACKAGE
(TOP VIEW)



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**TEXAS
INSTRUMENTS**

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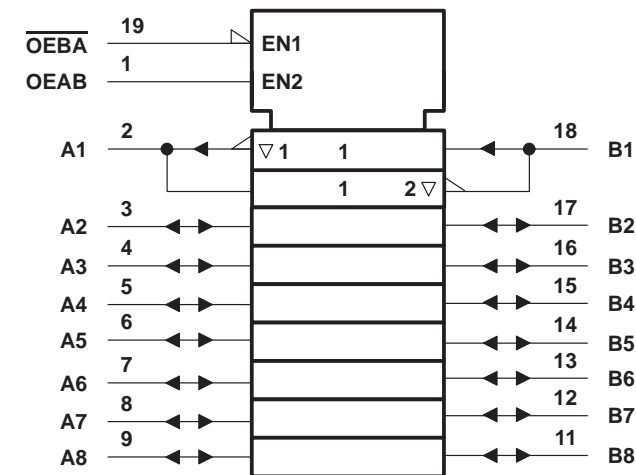
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OCTAL BUS TRANSCEIVERS
WITH 3-STATE OUTPUTS

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FUNCTION TABLE

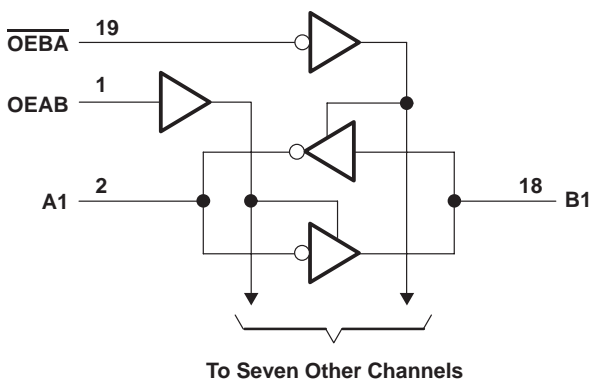
| INPUTS | | OPERATION |
|--------|------|--|
| OEBA | OEAB | |
| L | L | \overline{B} data to A bus |
| L | H | \overline{B} data to A bus, A data to B bus |
| H | L | Isolation |
| H | H | \overline{A} data to B bus |

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

| | |
|---|-----------------|
| Supply voltage range, V_{CC} | –0.5 V to 7 V |
| Input voltage range, V_I (see Note 1) | –0.5 V to 7 V |
| Voltage range applied to any output in the high or power-off state, V_O | –0.5 V to 5.5 V |
| Current into any output in the low state, I_O : SN54ABT620 | 96 mA |
| SN74ABT620 | 128 mA |
| Input clamp current, I_{IK} ($V_I < 0$) | –18 mA |
| Output clamp current, I_{OK} ($V_O < 0$) | –50 mA |
| Package thermal impedance, θ_{JA} (see Note 2): DB package | 115°C/W |
| DW package | 97°C/W |
| N package | 67°C/W |
| PW package | 128°C/W |
| Storage temperature range, T_{stg} | –65°C to 150°C |

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

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recommended operating conditions (see Note 3)

| | | | SN54ABT620 | | SN74ABT620 | | UNIT |
|-----------------|------------------------------------|-----------------|------------|-----------------|------------|-----------------|------|
| | | | MIN | MAX | MIN | MAX | |
| V _{CC} | Supply voltage | | 4.5 | 5.5 | 4.5 | 5.5 | V |
| V _{IH} | High-level input voltage | | 2 | | 2 | | V |
| V _{IL} | Low-level input voltage | | | 0.8 | | 0.8 | V |
| V _I | Input voltage | | 0 | V _{CC} | 0 | V _{CC} | V |
| I _{OH} | High-level output current | | | –24 | | –32 | mA |
| I _{OL} | Low-level output current | | | 48 | | 64 | mA |
| Δt/Δv | Input transition rise or fall rate | Outputs enabled | | 5 | | 5 | ns/V |
| T _A | Operating free-air temperature | | –55 | 125 | –40 | 85 | °C |

NOTE 3: All unused pins (control or I/O) of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SN54ABT620, SN74ABT620

OCTAL BUS TRANSCEIVERS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | T _A = 25°C | | | SN54ABT620 | | SN74ABT620 | | UNIT |
|--------------------|----------------|--|-----------------------|------|-------|------------|------|------------|------|------|
| | | | MIN | TYP† | MAX | MIN | MAX | MIN | MAX | |
| V _{IK} | | V _{CC} = 4.5 V, I _I = -18 mA | | | -1.2 | | -1.2 | | -1.2 | V |
| V _{OH} | | V _{CC} = 4.5 V, I _{OH} = -3 mA | | 2.5 | | | 2.5 | | 2.5 | V |
| | | V _{CC} = 5 V, I _{OH} = -3 mA | | 3 | | | 3 | | 3 | |
| | | V _{CC} = 4.5 V | | 2 | | | 2 | | | |
| | | | | 2* | | | | | 2 | |
| V _{OL} | | V _{CC} = 4.5 V | | | 0.55 | | 0.55 | | | V |
| | | | | | 0.55* | | | | 0.55 | |
| V _{hys} | | | | 100 | | | | | | mV |
| I _I | Control inputs | V _{CC} = 5.5 V, V _I = V _{CC} or GND | | | ±1 | | ±1 | | ±1 | μA |
| | A or B ports | | | | ±100 | | ±100 | | ±100 | |
| I _{OZH} ‡ | | V _{CC} = 5.5 V, V _O = 2.7 V | | | 50 | | 50 | | 50 | μA |
| I _{OZL} ‡ | | V _{CC} = 5.5 V, V _O = 0.5 V | | | -50 | | -50 | | -50 | μA |
| I _{off} | | V _{CC} = 0, V _I or V _O ≤ 4.5 V | | | ±100 | | | | ±100 | μA |
| I _{CEX} | | V _{CC} = 5.5 V, V _O = 5.5 V, Outputs high | | | 50 | | 50 | | 50 | μA |
| I _O § | | V _{CC} = 5.5 V, V _O = 2.5 V | -50 | -100 | -180 | -50 | -180 | -50 | -180 | mA |
| I _{CC} | A or B ports | V _{CC} = 5.5 V, I _O = 0, V _I = V _{CC} or GND | | | 5 | | 250 | | 250 | μA |
| | | | | | 24 | | 30 | | 30 | mA |
| | | | | | 0.5 | | 250 | | 250 | μA |
| ΔI _{CC} ¶ | Data inputs | V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND | | | 1.5 | | 1.5 | | 1.5 | mA |
| | | | | | 0.05 | | 0.05 | | 0.05 | |
| | Control inputs | V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND | | | 1.5 | | 1.5 | | 1.5 | |
| C _i | Control inputs | V _I = 2.5 V or 0.5 V | | | 4 | | | | | pF |
| C _{io} | A or B ports | V _O = 2.5 V or 0.5 V | | | 7 | | | | | pF |

* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at V_{CC} = 5 V.

‡ The parameters I_{OZH} and I_{OZL} include the input leakage current.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$ | | SN54ABT620 | | SN74ABT620 | | UNIT |
|-----------|--------------------------|----------------|---|-----|------------|-----|------------|-----|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{PLH} | A or B | B or A | 1 | 4.1 | 1 | | 1 | 4.8 | ns |
| t_{PHL} | | | 1 | 4.3 | 1 | | 1 | 4.8 | |
| t_{PZH} | $\overline{\text{OEBA}}$ | A | 1.3 | 4.6 | 1.3 | | 1.3 | 5.5 | ns |
| t_{PZL} | | | 1 | 6.1 | 1 | | 1 | 7.1 | |
| t_{PHZ} | $\overline{\text{OEBA}}$ | A | 2 | 6.3 | 2 | | 2 | 7 | ns |
| t_{PLZ} | | | 1.4 | 5.4 | 1.4 | | 1.4 | 5.8 | |
| t_{PZH} | OEAB | B | 1.6 | 6.2 | 1.6 | | 1.6 | 6.8 | ns |
| t_{PZL} | | | 2 | 5.9 | 2 | | 2 | 6.4 | |
| t_{PHZ} | OEAB | B | 1.2 | 5.6 | 1.2 | | 1.2 | 6.5 | ns |
| t_{PLZ} | | | 1.1 | 4.7 | 1.1 | | 1.1 | 5.6 | |

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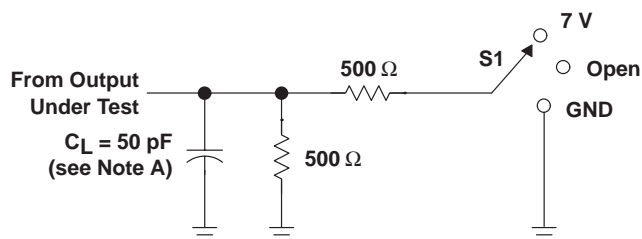


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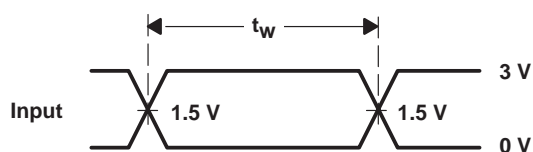
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PARAMETER MEASUREMENT INFORMATION

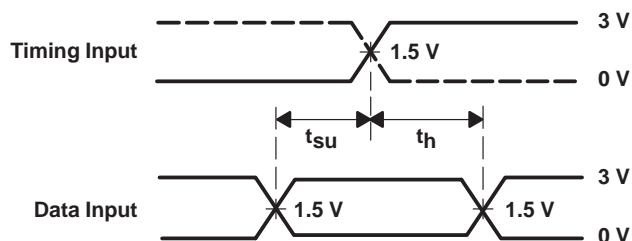


LOAD CIRCUIT

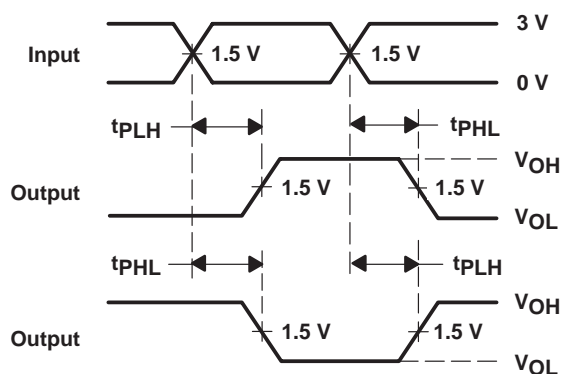
| TEST | S1 |
|-------------------|------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | 7 V |
| t_{PHZ}/t_{PZH} | Open |



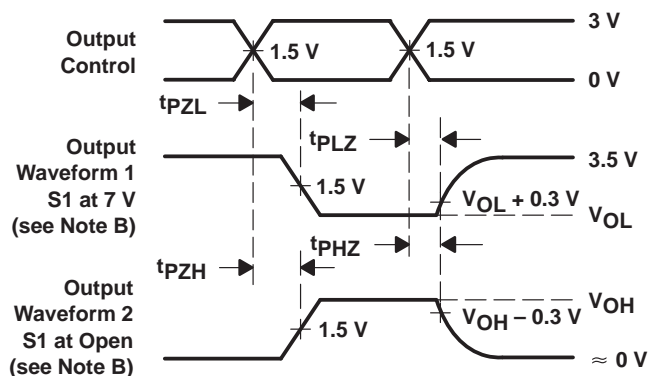
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN74ABT620DBLE | OBSOLETE | SSOP | DB | 20 | | TBD | Call TI | Call TI |
| SN74ABT620DBR | ACTIVE | SSOP | DB | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT620DBRE4 | ACTIVE | SSOP | DB | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT620DW | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT620DWE4 | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT620DWR | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT620DWRE4 | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT620N | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| SN74ABT620NE4 | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| SN74ABT620NSR | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT620NSRE4 | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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